TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

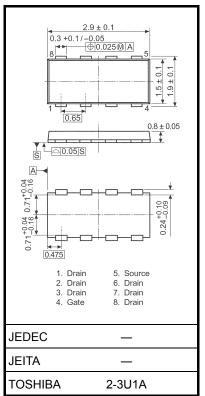
TPCF8102

Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: $RDS(ON) = 24 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 14 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -20 \ V)$
- Enhancement mode: V_{th} = -0.5 to -1.2 V $(V_{DS} = -10 \text{ V}, \text{ I}_D = -200 \text{ }\mu\text{A})$

Absolute Maximum Ratings (Ta = 25°C)

| Characte | ristics | Symbol | Rating | Unit | |
|-------------------------|---------------------------|------------------|---------|------|--|
| Drain-source voltage | | V _{DSS} | -20 | V | |
| Drain-gate voltage (R | _{GS} = 20 kΩ) | V _{DGR} | -20 | V | |
| Gate-source voltage | | V _{GSS} | ±8 | V | |
| Drain ourrant | DC (Note 1) | Ι _D | -6 | ٨ | |
| Drain current | Pulsed (Note 1) | I _{DP} | -24 | A | |
| Drain power dissipation | on (t = 5 s) (Note 2a) | PD | 2.5 | W | |
| Drain power dissipati | on (t = 5 s) (Note 2b) | PD | 0.7 | W | |
| Single pulse avalanch | ne energy (Note 3) | E _{AS} | 5.9 | mJ | |
| Avalanche current | | I _{AR} | -3 | А | |
| Repetitive avalanche | energy (Note 4) | E _{AR} | 0.25 | mJ | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature | range | T _{stg} | -55~150 | °C | |



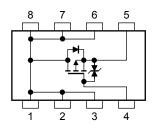
Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|-------|------|
| Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a) | R _{th (ch-a)} | 50.0 | °C/W |
| Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2b) | R _{th (ch-a)} | 178.6 | °C/W |

Circuit Configuration



Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Electrical Characteristics (Ta = 25°C)

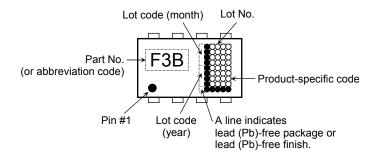
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|--|---------------------------------------|----------------------|---|------|-------|------|------|--|
| Gate leakage cui | rrent | I _{GSS} | $V_{GS}=\pm 8~V,~V_{DS}=0~V$ | _ | | ±10 | μA | |
| Drain cut-off curr | rent I _{DSS} V _{DS} | | $V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | _ | | -10 | μA | |
| Drain-source breakdown voltage | | V (BR) DSS | $I_D = -10$ mA, $V_{GS} = 0$ V | -20 | — — v | | V | |
| | | V (BR) DSX | $I_D = -10$ mA, $V_{GS} = 8$ V | -12 | | | v | |
| Gate threshold ve | oltage | V _{th} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -200 \mu\text{A}$ | -0.5 | _ | -1.2 | V | |
| | | R _{DS (ON)} | $V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$ | _ | 67 | 90 | | |
| Drain-source ON resistance | | R _{DS (ON)} | $V_{GS} = -2.5$ V, $I_D = -3.0$ A | _ | 36 | 41 | mΩ | |
| | | R _{DS (ON)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$ | _ | 24 | 30 | | |
| Forward transfer | admittance | Y _{fs} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$ | 7 | 14 | _ | S | |
| Input capacitance | | C _{iss} | V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz | | 1550 | _ | pF | |
| Reverse transfer capacitance | | C _{rss} | | | 215 | _ | | |
| Output capacitance | | C _{oss} | | | 265 | _ | | |
| Switching time | Rise time | tr | $V_{GS} \xrightarrow[-5]{0} V \xrightarrow[-5]{0} I_{D} = -3.0 \text{ A}$ | _ | 7 | _ | | |
| | Turn-on time | t _{on} | | _ | 13 | | | |
| | Fall time | t _f | | _ | 21 | _ | ns | |
| | Turn-off time | t _{off} | $V_{DD} \simeq -10 \text{ V}$ Duty $\leq 1\%, t_W = 10 \mu\text{s}$ | _ | 68 | _ | | |
| Total gate charge (gate-source plus gate-drain) | | Qg | $V_{DD} \simeq -16 V, V_{GS} = -5 V,$ | | 19 | | | |
| Gate-source charge | | Q _{gs} | $I_{\rm D} = -6.0 \rm{A}$ | | 14 | | nC | |
| Gate-drain ("miller") charge | | Q _{gd} | | _ | 5 | | | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Charact | Characteristics Symbol | | Test Condition | Min | Тур. | Max | Unit |
|-----------------------|--------------------------------------|------------------|---|-----|------|-----|------|
| Drain reverse current | Pulse (Note 1) | I _{DRP} | — | _ | _ | -24 | А |
| Forward voltage | ard voltage (diode) V _{DSF} | | $I_{DR} = -6.0 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$ | _ | _ | 1.2 | V |

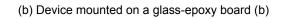
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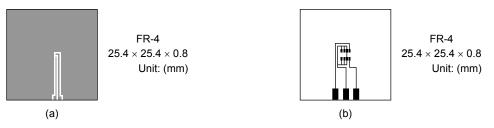
Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150 $^{\circ}\text{C}.$

Note 2: (a) Device mounted on a glass-epoxy board (a)



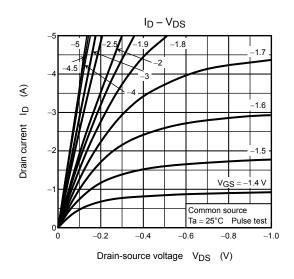


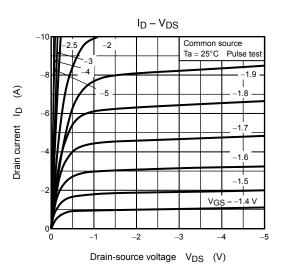
Note 3: $V_{DD} = -16 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = -3.0 A

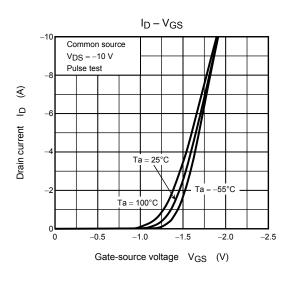
Note 4: Repetitive rating: pulse width limited by maximum channel temperature

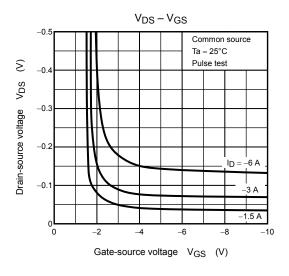
Note 5: A dot on the lower left of the marking indicates Pin 1.

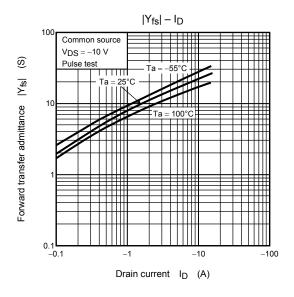
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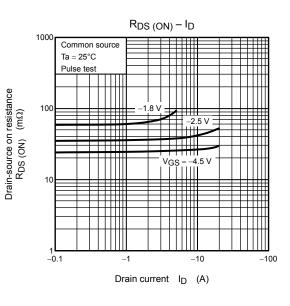




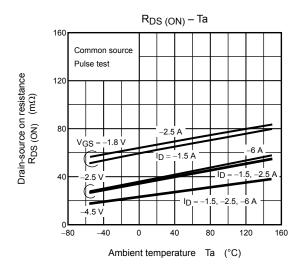


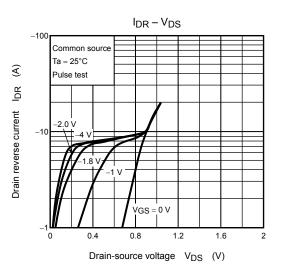


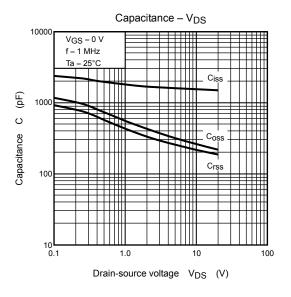


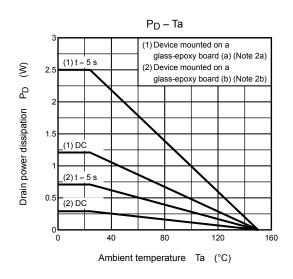


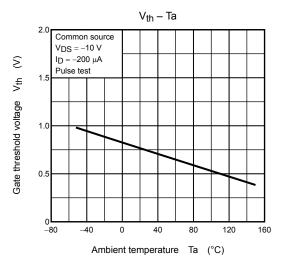
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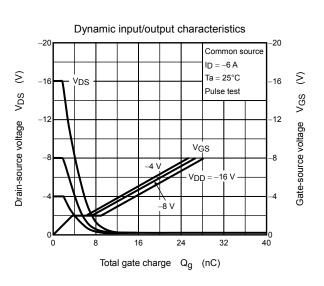


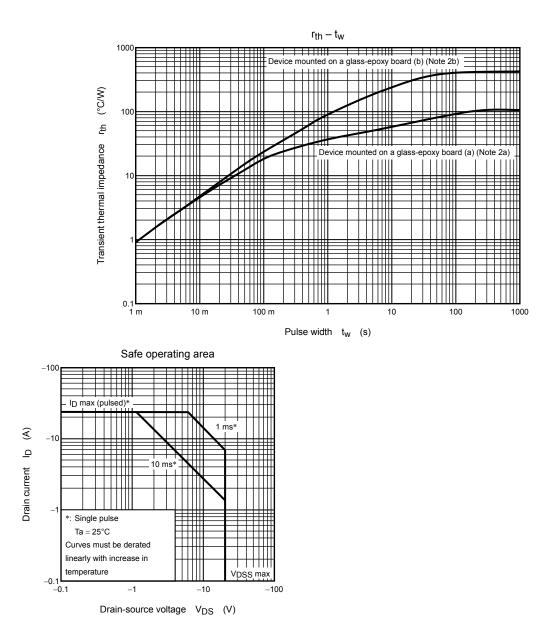












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